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Title:Panel and rump sessions

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Abstract: The IEEE 2012 International Microwave Symposium (IMS2012), to be held in Montre´ al, Canada, on June 17-19, 2012, will include various interesting panel sessions and rump sessions. The subjects covered in this year's panels include terahertz-integrated circuits, RF scaling, RF MEMs, LDMOS devices, and MIMO systems. This year's rump session will address communication skills and how making strong first impressions is vital for success in academia and industry. Various topics to be discussed in these sessions include 'THz Integrated Circuits: Do Future Markets Support Highly Integrated Silicon-Based IC Development?', 'RF Scaling: Can It Keep Up with Digital CMOS? Should It?', and 'RF MEMS for Defense and Aerospace'. 'How Will LDMOS and III-V Device Technologies Play in Cellular Infrastructure Future Markets?' and 'Human Aspects of Communication and Persuasion: First Impressions and Subtext' will also be discussed.

Abstract type:(Edited Abstract)

Main heading:Digital integrated circuits

Controlled terms:Communication - MIMO systems - MOS devices

Uncontrolled terms:Cellular infrastructure - Communication skills - Device technologies - Digital CMOS - Highly integrated - Human aspects - International microwave symposiums - LDMOS devices - Panel session - RF-MEMS - Silicon-based

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